

## **BONDING STRUCTURE WITH PILLAR AND CAP**

Appl. No. : 10/055,580 Confirmation No. 6089  
Applicant : Jin-Yuan Lee,  
Chien-Kang Chou,  
Shih-Hsiung Lin,  
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TC/A.U. : 2813  
Examiner : Mitchell, James M  
Docket No. : MEGP0003USA0  
Customer No. : 27765

Commissioner for Patents  
P.O. Box 1450  
Alexandria VA 22313-1450

### **AMENDMENT**

Sir:

- 5 The Office Action mailed Jul. 25, 2006 has been carefully considered. In response thereto, please enter the following amendments and consider the following remarks:

**Amendments to the Specification** begin on page 2 of this paper.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 3 of this paper.

10

**Remarks/Arguments** begin on page 10 of this paper.